



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Manufacturing Info/ Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Penica, John R	<b>Contact Title</b>	Mgr Environmental Engineering		
<b>Company Unique ID</b>	-	<b>Response Date</b>	2014-06-23	<b>Contact Email</b>	jrpenica@te.com				
<b>Contact Phone Number</b>	17175923266								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	280362	<b>Amount</b>	866.9	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>		<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EURoHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions - true								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products - true								
<b>EUREACH-0613</b>	Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH - true								
<b>Manufacturing Information</b>									
<b>J-STD-020 MSL Rating</b>		<b>Max Total a Wave Time</b>		<b>Ramp Rate</b>		<b>Wave Additional Info</b>			
<b>Classification Temp</b>		<b>Max Wave Solder Time</b>	0.0	<b>Ramp Down Rate</b>		<b>Psi Rating Reflow</b>			
<b>Max Time Within 5</b>		<b>Psi Rating Wave</b>		<b>Package Designator</b>		<b>Size</b>	0.0		
<b>Time Above 217</b>		<b>Reflow Additional Info</b>		<b>Preheat Max Temp</b>		<b>Terminal Base Alloy</b>	NAC		
<b>Preheat Duration</b>		<b>bulk Solder Termination</b>	NAC	<b>Nbr or Reflow Cycles</b>		<b>Terminal Plating</b>	NAC		
<b>Preheat Min Temp</b>		<b>Nbr of Instances</b>	0	<b>Component Temp Spike</b>		<b>Shape</b>	NAC		
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	Phenylene Oxide Compound				1.0	866.9	mg	
Material	2	PPE+PS				1.0	866.9	mg	
Substance	3	Phenol, 2,6-dimethyl-, homopolymer	Supplier	25134-01-4	46.2	1.0	400.5078	mg	
Substance	3	Benzene, ethenyl-, polymer with 1,3-butadiene	Supplier	9003-55-8	40.0	1.0	346.76	mg	
Substance	3	Phosphoric acid, triphenyl ester	Supplier	115-86-6	1.0	1.0	8.669	mg	
Substance	3	Phosphoric acid, P,P-1,3-phenylene P,P,P,P-tetraphenyl ester	Supplier	57583-54-7	8.0	1.0	69.352	mg	
Substance	3	Magnesium oxide (MgO)	Supplier	1309-48-4	0.3	1.0	2.6007	mg	
Substance	3	Benzene, methyl-	Supplier	108-88-3	0.1	1.0	0.8669	mg	
Substance	3	Phosphorous acid, triisodecyl ester	Supplier	25448-25-3	1.0	1.0	8.669	mg	
Substance	3	Carbon black	Supplier	1333-86-4	0.1	1.0	0.8669	mg	
Substance	3	Zinc sulfide (ZnS)	Supplier	1314-98-3	0.3	1.0	2.6007	mg	
Substance	3	1-Butene, polymer with ethene	Supplier	25087-34-7	3.0	1.0	26.007	mg	